SCS:kdn 11/06/02 151447.doc PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Chien-Ping Huang et al.

Application No. 10/001,862

Filed: November 19, 2001

For: CHIP PACKAGE CAPABLE OF REDUCING

MOISTURE PENETRATION

Examiner: Alonzo Chambliss

Date: November 6, 2002

BOX NON-FEE AMENDMENT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231 Art Unit: 2827

CERTIFICATE OF MAILING

I hereby certify that this paper and the documents referred to as being attached or enclosed herewith are being deposited with the United States Postal Service on November 6, 2002 as First Class Mail in an envelope addressed to: BOY NONFEE AMENDMENT COMMISSIONED BY PATENTS WASHINGTON, D. 42051.

Stacey C. Slater Attorney for Applicant

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AMENDMENT AND RESPONSE TO RESTRICTION REQUIREMENT

This responds to the Office action dated October 07, 2002, concerning the application referenced above. Please amend the application as follows.

In the Claims:

Please cancel claims 1-9 and 17 without prejudice or disclaimer.

REMARKS

The Office action requires applicants to restrict the present application to what the Patent Office contends is one independent and distinct invention. Applicants elect claims 10-16 (for a chip package where conduction line has one end connected to a bonding finger) for prosecution in the present application. The election is made without traverse.

Applicant has canceled claims 1-9 and 17 without prejudice or disclaimer, but retains the right to reintroduce any subject matter canceled by the present Amendment at any time during the prosecution of this application or any further application claiming benefit of this application.

The present application is in condition for allowance and such action is requested.

Respectfully submitted,

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